

YMU765 MA-5 Mobile Audio 5

Outline

YMU765 is a synthesizer LSI for mobile phones that realize advanced game sounds of Java application program etc. This LSI has a built-in speaker amplifier, and thus, is an ideal device for outputting sounds that are used by mobile phones in addition to game sounds and ringing melodies that are replayed by a synthesizer.

The synthesizer section adopts the "Stereophonic Hybrid Synthesizer System" which is given advantages of both FM synthesizers and Wave Table synthesizers to allow simultaneous generation of up to 32 FM voices and 32 Wave Table voices. Furthermore, the stream playback function, the voice synthesis function by HV (Humanoid Voice) synthesizer (*), and the time-variant low pass filter function by AL (Analog Lite) synthesizer have also on board.

Since FM synthesizer is able to present countless voices by specifying parameters with only several tens of bytes, memory capacity and communication band can be saved, and thus, the device exhibits the features in operating environment of mobile phones such as allowing distribution of arbitrary melodies with voices. On the other hand, Wave Table synthesizer can pronounce the voice built in ROM and arbitrary ADPCM/PCM voices from sequencer by the download of the melody with voices etc..

YMU765 has a built-in hardware sequencer that helps to realize a complex play without heavily loading the host CPU. In addition, it is possible to create more highly efficient applications by the voice synthesis function (*) and the function of time-variant low pass filter. Moreover, the device also has a built-in circuit for controlling vibrators and LEDs synchronizing with play of music.

(*) HV synthesizer function only responds to Japanese and Korean language at present.

Features

- Built-in the hybrid synthesizer, and possible to generate 64 tones simultaneously as maximum.
- Voice synthesis voice function by HV (Humanoid Voice) synthesizer is on board.
- (*) HV synthesizer function only responds to Japanese and Korean language at present.
- The time fluctuation low pass filter function by AL (Analog Lite) synthesizer is on board.
- Stream replay with ADPCM / PCM is possible.
- Has built-in default voices for FM and Wave Table synthesizers in the ROM, and the voices can be downloaded to RAM.
- Equipped with speaker amplifier and equalizer circuit.
- Equipped with a stereophonic output terminal for headphone.
- Equipped with vibration control circuit, and LED lighting control circuit.
- Has built-in PLL and inputting of master clock up to 20 MHz is possible and compiles with the TCXO (Temperature Compensated Crystal Oscillator).
- Contains a 16-bit stereophonic D/A converter.
- Has power down mode.
- Power supply for core $2.65V \sim 3.30V$
- Power supply for I/O $1.65V \sim VDD$
- Power supply for speaker amplifier VDD ~ 4.50V
- 32-pin QFN plastic package

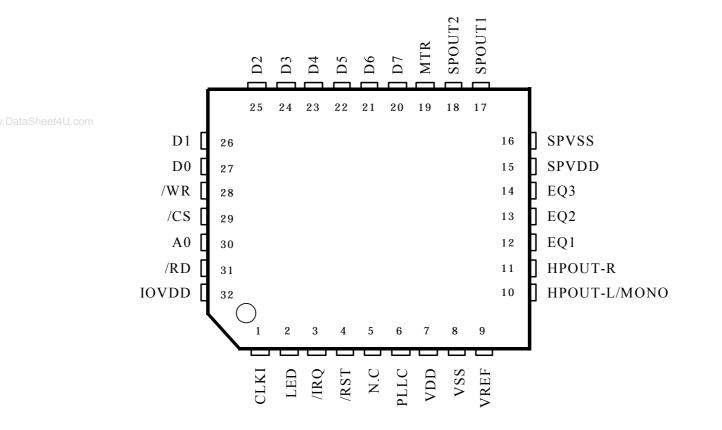
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YMU765 CATALOG CATALOG No : LSI-4MU765A2 2003.7WWW.DataSheet4U.com



YMU765

Pin configuration



<32pin QFN Top View>



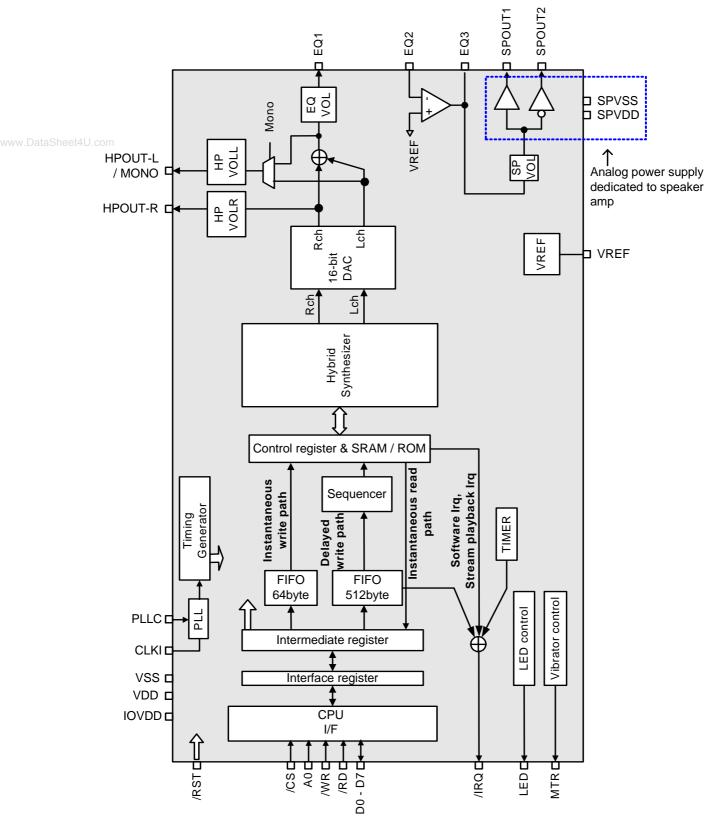
Pin functions

| | No. | Pin name | I/O | Power supply | Function |
|---------------------|-----|-------------------|-----|--------------|---|
| | 1 | CLKI | Ish | VDD | Clock input (1.5 MHz ~ 20 MHz) Correspond with TCXO. |
| | 2 | LED | 0 | IOVDD | External LED control |
| | 3 | /IRQ | 0 | IOVDD | Interrupt output |
| | 4 | /RST | Ish | IOVDD | Hardware reset input |
| | 5 | N.C | _ | _ | No Connection (Be sure to use without connection.) |
| www.DataSheet4U.con | 6 | PLLC | А | VDD | Connection of capacitor for built-in PLL Connect a series connection of 1000 pF capacitor and 3.3 kΩ resistor between this pin and VSS(*). (*)Directly connect VSS used here and VSS of 8 th pin. |
| | 7 | VDD | _ | _ | Power supply (2.65 ~ 3.30V) Connect 0.1 μ F and 4.7 μ F capacitors between this pin and VSS. |
| | 8 | VSS | _ | _ | Ground |
| | 9 | VREF | А | VDD | Analog reference voltage: Connect 0.1 μ F capacitor between this pin and VSS. |
| | 10 | HPOUT-L / MONO | А | VDD | Headphone output Lch (Can be used as MONO output) |
| | 11 | HPOUT-R | А | VDD | Headphone output Rch |
| | 12 | EQ1 | А | VDD | Equalizer pin 1 |
| | 13 | EQ2 | Α | VDD | Equalizer pin 2 |
| | 14 | EQ3 | Α | VDD | Equalizer pin 3 |
| | 15 | SPVDD | _ | _ | Speaker amplifier analog power supply (VDD ~ 4.50V) Connect 0.1 μ F and 4.7 μ F capacitors between this pin and SPVSS. |
| | 16 | SPVSS | - | _ | Speaker amplifier analog ground |
| | 17 | SPOUT1 | А | SPVDD | Speaker connection pin 1 |
| | 18 | SPOUT2 | Α | SPVDD | Speaker connection pin 2 |
| | 19 | MTR | 0 | IOVDD | External motor control pin |
| | 20 | D7 | I/O | IOVDD | CPU I/F data bus 7 |
| | 21 | D6 | I/O | IOVDD | CPU I/F data bus 6 |
| | 22 | D5 | I/O | IOVDD | CPU I/F data bus 5 |
| | 23 | D4 | I/O | IOVDD | CPU I/F data bus 4 |
| | 24 | D3 | I/O | IOVDD | CPU I/F data bus 3 |
| | 25 | D2 | I/O | IOVDD | CPU I/F data bus 2 |
| | 26 | D1 | I/O | IOVDD | CPU I/F data bus 1 |
| | 27 | D0 | I/O | IOVDD | CPU I/F data bus 0 |
| | 28 | /WR | Ι | IOVDD | CPU I/F write enable |
| | 29 | /CS | Ι | IOVDD | CPU I/F chip select |
| | 30 | A0 | Ι | IOVDD | CPU I/F address signal |
| | 31 | /RD | Ι | IOVDD | CPU I/F read enable |
| | 32 | IOVDD | _ | — | Pin power supply (1.65 ~ VDD) |

A : Analog pin Ish : Schmitt input



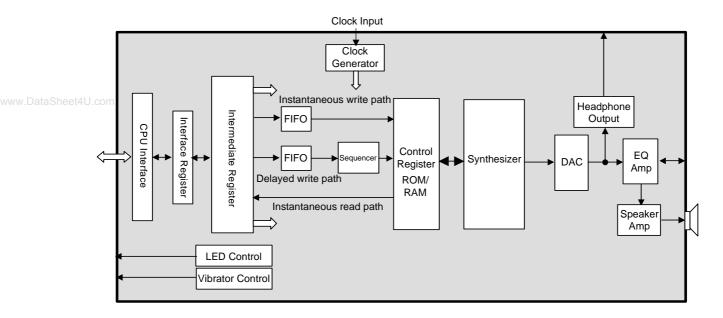
Block diagram





Outline of blocks

This section outlines functions of blocks contained in this device and flow of signals.



CPU interface

CPU interface is an 8-bit parallel type.

It assumes that a total of 13 pins of 4 control signals (/WR, /RD, /CS, A0 pin), 8 data bus (D0 to D7), and 1 Interrupt pin (/IRQ) are connected to the external CPU.

This block controls the writing and reading of data by the input polarity of control signal.

Interface register

This register is able to access directly from the external CPU. There are 2 bytes spaces. The latter Intermediate register can be accessed through the Interface register.

Intermediate register

This register is accessed through the Interface register.

The "Control register" and ROM/SRAM, which describes below, can be accessed through this register. This register is called the "Intermediate register" since this exists in the middle of the Interface register and the Control register.

In the Intermediate register, there are some registers to control various functions.

Control register, ROM/SRAM

The Control register and ROM/SRAM are accessed from "Instantaneous write register", "Delayed write register", and "Instantaneous read register" in the Intermediate register.

In the Control register, there is a register to control the following synthesizer mainly.

The voice parameter for FM (GM 128 voices + DRUM 40 voices) and Wave data for WT are stored in ROM.

SRAM is used at the download of arbitrary FM voice parameter and Wave data for WT.

Moreover, it is used as storing buffer at the stream playback of PCM/ADPCM.

FIFO

This is an abbreviation of "First In First Out" means the memory which data is read in order of written. There are 2 paths to write into FIFO in the Intermediate register.

The "Instantaneous write path" is for accessing the Control register and ROM/SRAM immediately, also "Delayed write path" is for accessing the Control register after managing time through the sequencer. FIFO size of Instantaneous path is 64-byte, and its size of Delayed path is 512-byte.



Sequencer

This is for interpreting the contents of data which was written into the Delayed write path. Generally, "Music data" is written into the Delayed write path. It interprets the contents of music data and controls the synthesizer after sequencer, and then plays the music.

Hybrid synthesizer

This device contains a built-in Polyphonic synthesizer that adopts a stereophonic hybrid system that generates up to 64 tones.

FM synthesizer, WT (Wave Table) synthesizer, Stream playback, HV (Humanoid Voice) synthesizer (*), and AL (Analog Lite) synthesizer are available.

(*) HV synthesizer function only responds to Japanese and Korean language at present.

LED, Vibrator control

It is possible to synchronize an LED and vibrator with a play, and to control. A synchronous control to a play is also possible.

Clock generating block

This device supports a clock input ranging from 1.5 MHz to 20 MHz. (Stop = 0 Hz is possible at power down.) It is a block to generate a clock which is needed inside of LSI in the PLL.

DAC

It converts digital signals from a synthesizer and a digital audio section into analog signals. The length of a data is 16bits.

Headphone output

This is an amplifier of Stereophonic output for Headphone. The monaural output is also possible.

EQ amplifier

The change of Filter characteristic and gain is possible by adjusting the resistors and external parts.

Speaker amplifier

A speaker amplifier, which has maximum output power of 580 mW at SPVDD=3.6V, is integrated this device. There is a volume to adjust output level in the first part of amplifier.



Electrical Characteristics

Absolute maximum rating

| | Item | Symbol | Min. | Max. | Unit |
|---------------|---|-------------------|------|-----------|------|
| - | power supply voltage nplifier section) | SPVDD | -0.3 | 6.0 | V |
| VDD pin, po | ower supply voltage | VDD | -0.3 | 4.2 | V |
| IOVDD pin, | power supply voltage | IOVDD | -0.3 | 4.2 | V |
| SPOUT1, SI | OUT2 pin, applied voltage | V _{INSP} | -0.3 | SPVDD+0.3 | V |
| Analog inpu | t voltage | V _{INA} | -0.3 | VDD+0.3 | V |
| Digital input | voltage 1 (*1) | V _{IND1} | -0.3 | IOVDD+0.3 | V |
| Digital input | voltage 2 (*2) | V _{IND2} | -0.3 | VDD+0.3 | V |
| Permissible | loss (*3) | Pd | | 1197 | mW |
| Storage temp | perature | T _{STG} | -50 | 125 | °C |

[Condition] VSS = SPVSS = 0V

(*1) Target pin: D0 ~ D7, /CS, A0, /WR, /RD, /RST

(*2) Target pin: CLKI

(*3) Top= 25 °C, and glass epoxy PCB ($30mm \times 100mm \times 1.0mm$) is installed.

When operating above Top= 25 °C, permissible loss decreases 12 mW per 1 °C.

Recommended operating conditions

| Item | Symbol | Min. | Тур. | Max. | Unit |
|--|-----------------|------|------|------|------|
| SPVDD operating voltage (Speaker amplifier section) | SPVDD | VDD | 3.60 | 4.50 | V |
| VDD operating voltage | VDD | 2.65 | 3.00 | 3.30 | V |
| IOVDD operating voltage | IOVDD | 1.65 | 1.80 | VDD | V |
| Operating ambient temperature | T _{OP} | -20 | 25 | 85 | °C |

[Condition] VSS = SPVSS = 0V

Power consumption

| Item | Conditions | Тур. | Max. | Unit |
|--|-----------------------|------|------|------|
| Power consumption of VDD+IOVDD | Normal operation (*1) | 40 | | mA |
| At Silent sound generated SPVDD side | | 4 | | mA |
| At the time of output 400mW / 80hm load SPVDD side | | 210 | | mA |
| Power down mode $Ta = +25^{\circ}C$ | VDD+IOVDD+SPVDD (*2) | 0.5 | 2 | μΑ |
| Power down mode $Ta = +85^{\circ}C$ | VDD+IOVDD+SPVDD (*2) | | 10 | μΑ |

(*1) VDD=IOVDD=3.00V, SPVDD=3.60V, $T_{OP}=25^{\circ}C$

(*2) VDD=IOVDD=3.30V, SPVDD=4.50V

/CS input pin is fixed to V_{IH} =IOVDD, the other input pins are V_{IL} =VSS and V_{IH} =(IO)VDD.



DC characteristics

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|---------------------------|-------------------|----------------------|--------------------------|------------|---------------------|------|
| Input voltage "H" level 1 | V _{IH} | (*1) | $0.65 \times IOVDD$ | | | V |
| Input voltage "L" level 1 | V _{IL} | (*1) | | | $0.35 \times IOVDD$ | V |
| Input voltage "H" level 2 | V_{IH} | (*2) | $0.75 \times IOVDD$ | | | V |
| Input voltage "L" level 2 | V _{IL} | (*2) | | | $0.25 \times IOVDD$ | V |
| Input voltage "H" level 3 | V_{IH} | (*3) | $0.70 \times \text{VDD}$ | | | V |
| Input voltage "L" level 3 | V _{IL} | (*3) | | | $0.30 \times VDD$ | V |
| Output voltage "H" level | V _{OH} | $(*4) I_{OH} = (*5)$ | $0.80 \times IOVDD$ | | | V |
| Output voltage "L" level | V _{OL} | $(*4) I_{OL} = (*5)$ | | | $0.20 \times IOVDD$ | V |
| Schmitt width 1 | Vsh1 | /RST pin | | 0.10×IOVDD | | V |
| Schmitt width 2 | Vsh2 | CLKI pin | | 0.10×VDD | | V |
| Input leakage current | IL | | -1 | | 1 | μΑ |
| Input capacity | CI | | | | 10 | pF |

 $[Condition] T_{OP}=-20 \sim 85^{\circ}C, VDD=2.65 \sim 3.30V, IOVDD=1.65 \sim VDD[V], Capacitor load=50 \ pF$

(*1) Target pin: D0 ~ D7, /CS, A0, /WR, /RD

(*2) Target pin: /RST

(*3) Target pin: CLKI (In the case of CMOS mode)

(*4) Target pin: D0 ~ D7, /IRQ, LED, MTR

(*5) /IRQ, D0 ~ D7, are I_{OH} = -1 mA, I_{OL} = +1 mA

LED, MTR are $I_{OH} = -4 \text{ mA}$, $I_{OL} = +4 \text{ mA}$

However, when IOVDD is less than 2.65V, D0 ~ D7, /IRQ, LED, and MTR become I_{OH} =-0.2mA and I_{OL} =+0.2mA.



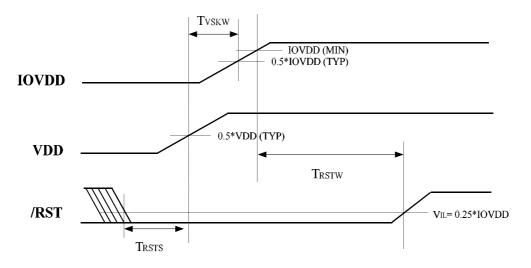
■ AC characteristics

Reset and clock timing

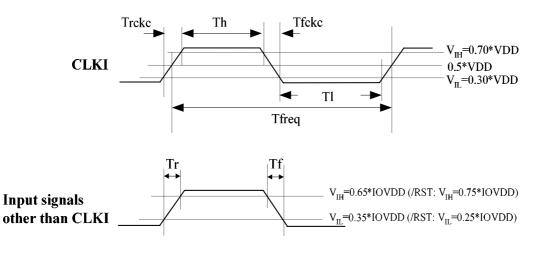
| Item | Symbol | Min. | Тур. | Max. | Unit |
|--|-------------------|------|------|------|------|
| /RST "L" pulse width | T _{RSTW} | 100 | | | μs |
| /RST (indefinite \rightarrow L) setup time | T _{RSTS} | 0 | | | μs |
| VDD - IOVDD rise time difference | T _{VSKW} | 0 | | 3 | ms |
| CLKI frequency | 1 / Tfreq | 1.5 | | 20 | MHz |
| CLKI rise / fall time | Treke / Tfeke | | | 30 | ns |
| CLKI High time | Th | 15 | | | ns |
| CLKI Low time | Tl | 15 | | | ns |
| Input signals other than CLKI rise / fall time | Tr / Tf | | | 20 | ns |

[Condition] T_{OP}=-20 ~ 85°C, VDD=2.65 ~ 3.30V, IOVDD=1.65 ~ VDD[V], Capacitor load=50 pF

The input to Clock can be stopped (=0Hz) during reset period and power down state (DP0=1). However, the input level is to be H or L, and input of intermediate level is prohibited. When VDD and IOVDD are used by respectively different power supply, make sure to rise from VDD first.



The reset width is defined as the time from the moment IOVDD has risen to 1.65V. /RST has to be settled at "L" level at the time VDD has risen to 50%.





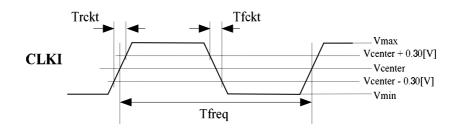
• CLKI (TCXO mode)

| Item | Symbol | Min. | Тур. | Max. | Unit |
|------------------------------------|----------------|------|------|-------------------|------|
| CLKI frequency | 1 / Tfreq | 1.5 | | 20 | MHz |
| CLKI rise / fall time | Trckt , Tfckt | | | 250 | ns |
| CLKI amplitude H | Vmax - Vcenter | 0.30 | | $0.35 \times VDD$ | V |
| CLKI amplitude L | Vcenter - Vmin | 0.30 | | $0.35 \times VDD$ | V |
| Wait time to stable operation (*1) | Twait | 2 | | | ms |
| Feedback resistance | Rck | 30 | 45 | 63 | kΩ |

[Condition] T_{OP} =-20 ~ 85°C, VDD=2.65 ~ 3.30V, Capacitor load=50pF

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(*1): The value at the AC coupling of TCXO parts and the CLKI pin by the capacity of 1000pF.



• The voltage level which Duty of CLKI becomes 50% (High time = Low time) is defined as Vcenter.

- Trckt and Tfckt are defined by the change time between Vcenter + 0.30[v] and Vcenter - 0.30[v].

• The timing observation level of Tfreq is to be Vcenter (Duty=50%).



CPU interface timing

| The AC characteristics of a CPU interface are measured on condition as follows. | | | | | | |
|---|---|--------------------------------|----------------------------|--|--|--|
| The input conditions at the time of measurement | : | $V_{IH} = 0.8 \times IOVDD$, | V _{IL} =0.2×IOVDD | | | |
| The measurement points | : | $V_{IH} = 0.65 \times IOVDD$, | $V_{IL}=0.35 \times IOVDD$ | | | |
| | | $V_{OH} = 0.65 \times IOVDD$, | $V_{OL}=0.35 \times IOVDD$ | | | |

• CPU interface 1 (In the case of IOVDD≧2.65V)

(Write cycle)

| Item | Symbol | Min | Max. | Unit |
|------------------------|------------------|-----|------|------|
| Address setup time | T _{ADS} | 50 | | ns |
| Address hold time | T _{ADH} | 0 | | ns |
| Chip select setup time | T _{CSS} | 50 | | ns |
| Chip select hold time | T _{CSH} | 0 | | ns |
| Write pulse width | T_{WW} | 50 | | ns |
| Data setup time | T _{WDS} | 30 | | ns |
| Data hold time | T _{WDH} | 0 | | ns |

 $\label{eq:condition} \ensuremath{\left[\text{Condition} \right] T_{\text{OP}} = -20 \sim 85^\circ\text{C}, \quad \ensuremath{\text{VDD}} = \text{IOVDD} = 2.65 \sim 3.30\text{V}, \quad \ensuremath{\text{Capacitor}} \ensuremath{\text{ load}} = 50 \ensuremath{\,\text{pF}} \ensuremath{\,\text{P}} \ensuremath{\,\text{OP}} \ensuremath{\,\text{OP}} = -20 \sim 85^\circ\text{C}, \quad \ensuremath{\,\text{VDD}} = \text{IOVDD} = 2.65 \sim 3.30\text{V}, \quad \ensuremath{\,\text{Capacitor}} \ensuremath{\,\text{load}} = 50 \ensuremath{\,\text{pF}} \ensuremath{\,\text{P}} \ensuremath{\,\text{OP}} \ensuremath{\,\text{P}} \ensuremath{\,\text{OP}} \ensuremath{\,\text{OP}} \ensuremath{\,\text{OP}} \ensuremath{\,\text{OP}} \ensuremath{\,\text{Capacitor}} \ensuremath{\,\text{OP}} \ensur$

(Read cycle)

| Item | Symbol | Min | Max. | Unit |
|---|--------------------|-----|------|------|
| Access time from /RD pin | T _{ACCRD} | | 70 | ns |
| Access time from /CS pin | T _{ACCCS} | | 70 | ns |
| Access time from /A0 pin | T _{ACCA0} | | 70 | ns |
| Data hold time from /RD pin | T _{DHRD} | 0 | | ns |
| Data hold time from /CS pin | T _{DHCS} | 0 | | ns |
| Data hold time from A0 pin | T _{DHA0} | 0 | | ns |
| High-impedance transition time from /RD pin | T _{DZRD} | | 30 | ns |
| High-impedance transition time from /CS pin | T _{DZCS} | | 30 | ns |

[Condition] T_{OP} =-20 ~ 85°C, VDD=IOVDD=2.65 ~ 3.30V, Capacitor load=50 pF

$$I_{OH}$$
= -1.0mA, I_{OL} = +1.0mA (D0 ~ D7 pin)



• CPU interface 2 (In the case of IOVDD < 2.65V)

| (Write | cvc | le) |
|-----------|-----|-----|
| (** 1100 | CyC | ic) |

| Item | Symbol | Min | Max. | Unit |
|------------------------|------------------|-----|------|------|
| Address setup time | T _{ADS} | 50 | | ns |
| Address hold time | T _{ADH} | 0 | | ns |
| Chip select setup time | T _{CSS} | 50 | | ns |
| Chip select hold time | T _{CSH} | 0 | | ns |
| Write pulse width | T_{WW} | 50 | | ns |
| Data setup time | T _{WDS} | 50 | | ns |
| Data hold time | T _{WDH} | 0 | | ns |

 $\label{eq:condition} \ensuremath{\left[\text{Condition} \right] T_{OP} = -20 \sim 85^\circ \text{C}, \quad \text{VDD} = 2.65 \sim 3.30 \text{V}, \quad \text{IOVDD} = 1.65 \sim \text{less than } 2.65 \text{V}, \quad \text{Capacitor load} = 30 \ensuremath{\left[\text{P} \ensuremath{\left[\text{Condition} \right] \ensuremath{\left[\text{Condition} \ensuremath{\left[\text{Condit{$

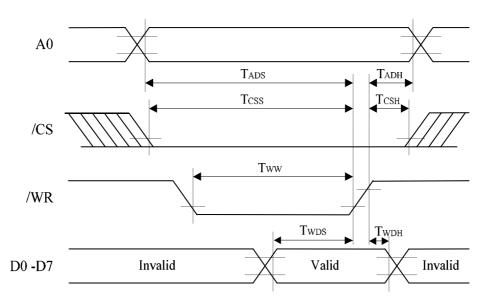
| (Read cycle) | | | | |
|---|--------------------|-----|------|------|
| Item | Symbol | Min | Max. | Unit |
| Access time from /RD pin | T _{ACCRD} | | 80 | ns |
| Access time from /CS pin | T _{ACCCS} | | 80 | ns |
| Access time from /A0 pin | T _{ACCA0} | | 80 | ns |
| Data hold time from /RD pin | T _{DHRD} | 0 | | ns |
| Data hold time from /CS pin | T _{DHCS} | 0 | | ns |
| Data hold time from A0 pin | T _{DHA0} | 0 | | ns |
| High-impedance transition time from /RD pin | T _{DZRD} | | 50 | ns |
| High-impedance transition time from /CS pin | T _{DZCS} | | 50 | ns |

 $\label{eq:condition} \begin{array}{l} T_{OP}\mbox{=-}20 \sim 85^{\circ}\mbox{C}, \quad VDD\mbox{=-}2.65 \sim 3.30\mbox{V}, \quad IOVDD\mbox{=-}1.65 \sim less than 2.65\mbox{V}, \quad Capacitor load\mbox{=-}30 \mbox{ pF} \\ I_{OH}\mbox{=-}0.2\mbox{mA}, \quad I_{OL}\mbox{=+}0.2\mbox{mA} \quad (D0 \sim D7 \mbox{ pin}) \end{array}$





Write cycle

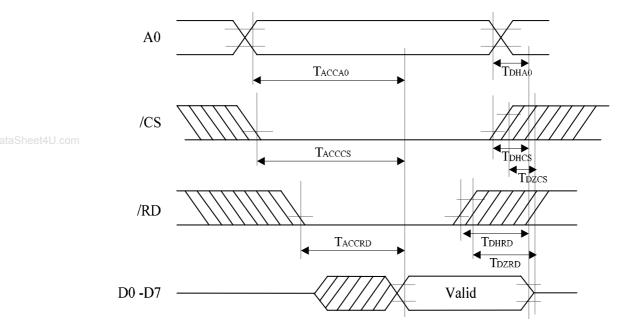


Note :

- T_{ADH} : The hold time of A0 pin, which is defined with respect to the point where the rise of /WR has reached 0.65*IOVDD under the condition that both two specifications (T_{CSH} , T_{WDH}) are secured more than minimum value (=0ns).
- T_{CSH} : The hold time of /CS pin, which is defined with respect to the point where the rise of /WR has reached 0.65*IOVDD under the condition that both two specifications (T_{ADH} , T_{WDH}) are secured more than minimum value (=0ns).
- $T_{WDH}: The hold time of D0 \sim D7 pins, which is defined with respect to the point where the rise of /WR has reached 0.65*IOVDD under the condition that both two specifications (T_{ADH}, T_{CSH}) are secured more than minimum value (=0ns).$
- T_{ADS}: The hold time of A0 pin, which is defined with respect to the point where /WR has become invalid (0.35*IOVDD) under the condition that all of three specifications (T_{CSS}, T_{WW}, T_{WDS}) are secured more than minimum value.
- $T_{CSS}: The hold time of /CS pin, which is defined with respect to the point where /WR has become invalid (0.35*IOVDD) under the condition that all of three specifications (T_{ADS}, T_{WW}, T_{WDS}) are secured more than minimum value.$



Read cycle



Note :

| T _{ACCA0} : | The access time until D0 ~ D7 are defined (0.65*IOVDD or 0.35*IOVDD) after A0 is defined (0.65*IOVDD or 0.35*IOVDD). Considers that /RD and /CS are defined beforehand (*1). |
|----------------------|---|
| T _{ACCCS} : | The access time until D0 ~ D7 are defined (0.65*IOVDD or 0.35*IOVDD) after /CS is defined (0.35*IOVDD). Considers that A0 and /RD are defined beforehand (*1). |
| T _{ACCRD} : | The access time until D0 ~ D7 are defined (0.65*IOVDD or 0.35*IOVDD) after /RD is defined (0.35*IOVDD). Considers that A0 and /CS are defined beforehand (*1). |
| T _{DHRD} : | The time (Hold time) until D0 ~ D7 output valid data after /RD becomes enable (= $0.35*IOVDD$) under the condition that A0 and /CS secure sufficient hold time (*2). |
| T _{DHCS} : | The time (Hold time) until D0 ~ D7 output valid data after /CS becomes enable (= $0.35*IOVDD$) under the condition that A0 and /RD secure sufficient hold time (*2). |
| T _{DHA0} : | The time (Hold time) until D0 ~ D7 output valid data after A0 becomes enable (0.65*IOVDD or 0.35*IOVDD) under the condition that /RD and /CS secure sufficient hold time (*2). |
| T _{DZRD} : | The time until D0 ~ D7 become high impedance status after /RD becomes disable (= $0.65*IOVDD$) under the condition that A0 and /CS secure sufficient hold time (*2). |
| T _{DZCS} : | The time until D0 ~ D7 become high impedance status after /CS becomes disable (= $0.65*IOVDD$) under the condition that A0 and /RD secure sufficient hold time (*2). |



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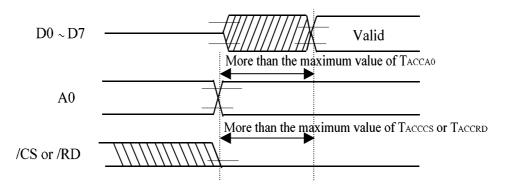
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(*1) "~ defined beforehand." means,

| n the case of /CS : | The status that /CS is defined (0.35*IOVDD) before more than the time of T_{ACCCS} with |
|---------------------|--|
| | respect to the point where D0 ~ D7 are defined (0.65*IOVDD or 0.35*IOVDD). |
| n the case of /RD : | The status that /RD is defined (0.35*IOVDD) before more than the time of $T_{\mbox{\scriptsize ACCRD}}$ with |
| | respect to the point where D0 ~ D7 are defined (0.65*IOVDD or 0.35*IOVDD). |
| n the case of A0 : | The status that A0 is defined (0.35*IOVDD or 0.65*IOVDD) before more than the time of |
| | T_{ACCA0} with respect to the point where D0 \sim D7 are defined (0.65*IOVDD or |
| | 0.35*IOVDD). |

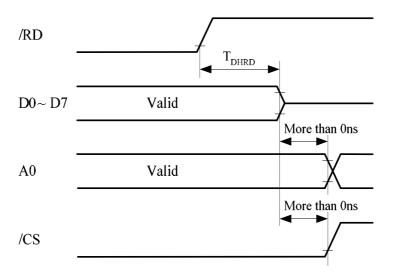
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(*2) "~ sufficient hold time" means,

| At T _{DHRD} measurement: | The status that the enable time of A0 and /CS pins input are secured more than 0ns with |
|-----------------------------------|---|
| | respect to the point where $D0 \sim D7$ can not hold valid data. |
| At T _{DHCS} measurement: | The status that the enable time of A0 and /RD pins input are secured more than 0ns |
| | with respect to the point where $D0 \sim D7$ can not hold valid data. |
| AT T_{DHA0} measurement: | The status that the enable time of /CS and /RD pins input are secured more than 0ns |
| | with respect to the point where $D0 \sim D7$ can not hold valid data. |

(Example: At T_{DHRD} measurement)



Analog characteristics

Conditions of T_{OP}=25°C, VDD=3.00V, IOVDD=1.80V, and SPVDD=3.60V apply to all items.

\circ SP amplifier

| Item | Min. | Typical | Max. | Unit |
|---|------|----------|------|-------|
| Gain setting (fixed) | | ±2 | | times |
| Min. load resistance (RL) | | 8 | | Ω |
| Max. output voltage amplitude (RL= 8Ω) | | 6.0 | | Vp-p |
| Max. output power (RL= 8Ω , THD+N $\leq 1.0\%$) | | 580 | | mW |
| THD + N (RL= 8Ω , f=1 kHz, output = 400mW) | | 0.025 | | % |
| Noise at no signal (A-filter: weighting filter) | | -90 | | dBV |
| PSRR (f=1 kHz) | | 90 | | dB |
| Amplitude center potential (VSEL2, VSEL1 =0, 0) | | 0.6×VDD | | V |
| (VSEL2, VSEL1 =0, 1) | | 0.5×VDD | | V |
| (VSEL2, VSEL1 =1, 0) | | 0.67×VDD | | V |
| Differential output voltage | | 10 | 50 | mV |
| Max. load capacity connectable to SPOUT1 and SPOUT2 pin (*) | | | 1000 | pF |

(*) : The maximum of 1000pF can be connected to SPOUT1 pin, and the maximum of 1000pF can be connected to SPOUT2 pin.

○ EQ amplifier

| Item | Min. | Typical | Max. | Unit |
|---|------|---------|------|------|
| Gain settable range | | | 30 | dB |
| Max. output voltage amplitude | | 2.7 | | Vp-p |
| THD + N $(f=1 \text{ kHz})$ | | | 0.05 | % |
| Noise at no signal (A-filter) | | -90 | | dBV |
| Input impedance | 10 | | | MΩ |
| Feedback resistance between EQ2 and EQ3 | 20 | | | kΩ |

• SP Volume

| Item | Min. | Typical | Max. | Unit |
|----------------------|------|---------|------|------|
| Volume setting range | -30 | | 0 | dB |
| Volume step width | | 1 | | dB |
| THD + N (f=1 kHz) | | | 0.05 | % |

• EQ Volume

| Item | Min. | Typical | Max. | Unit |
|-------------------------------|------|---------|------|------|
| Volume setting range | -30 | | 0 | dB |
| Volume step width | | 1 | | dB |
| Noise at no signal (A-filter) | | -90 | | dBV |
| Max. output current | 120 | | | μΑ |
| Max. output voltage amplitude | | 1.5 | | Vp-p |
| Output impedance | | 300 | 600 | Ω |



• HP Volume

| Item | Min. | Typical | Max. | Unit |
|-------------------------------|------|---------|------|------|
| Volume setting range | -30 | | 0 | dB |
| Volume step width | | 1 | | dB |
| Noise at no signal (A-filter) | | -90 | | dBV |
| Max. output current | 120 | | | μΑ |
| Max. output voltage amplitude | | 1.5 | | Vp-p |
| Output impedance | | 300 | 600 | Ω |

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○ VREF

| Item | Min. | Typical | Max. | Unit |
|--------------|------|---------|------|------|
| VREF voltage | | 0.5×VDD | | V |

\circ DAC

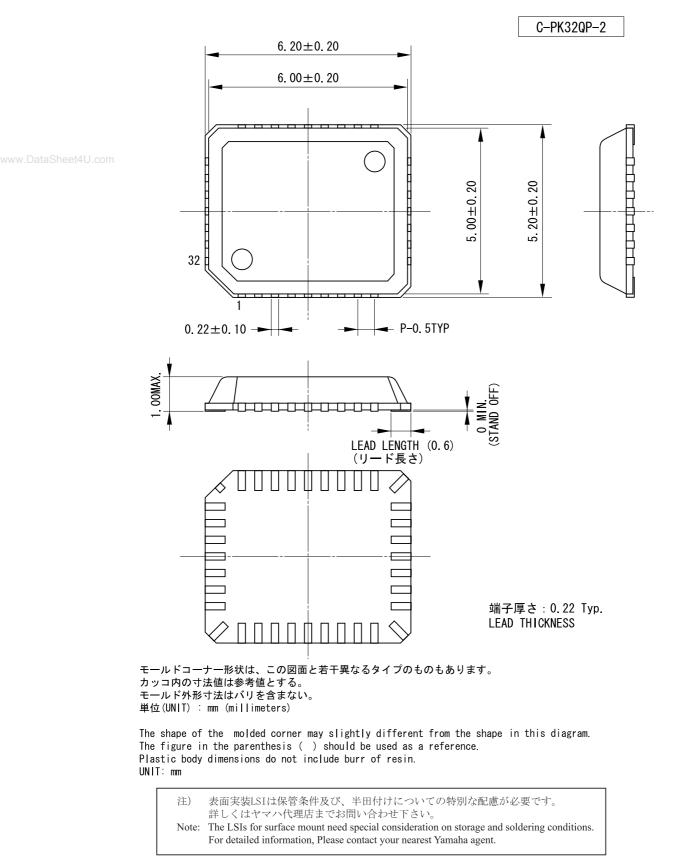
| Item | Min. | Typical | Max. | Unit |
|---------------------------------------|----------|---------|------|------|
| Resolution | | 16 | | Bit |
| Full scale output voltage | | 1.5 | | Vp-p |
| THD+N (f= 1 kHz) | | | 0.5 | % |
| Noise at no signal (A-filter) | | -85 | -80 | dBV |
| Frequency response (f=50Hz to 20 kHz) | -3.0 (*) | | +0.5 | dB |

(*): Reduction of response in high frequency range caused by aperture effect





External dimensions of package





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